CRITICAL THICKNESS AND BOW OF PSEUDOMORPHIC In_xGa_{1-x}As-BASED LASER HETEROSTRUCTURES GROWN ON (001)GaAs AND (001)InP SUBSTRATES

M.E. Rudinsky¹, S.Yu. Karpov^{1,2*}, H. Lipsanen^{2,3}, A.E. Romanov^{2,4}

¹STR Group – Soft-Impact, Ltd., P.O. Box 83, 27 Engels ave., St. Petersburg, 194156, Russia ²ITMO University, 49 Kronverkskiy ave., Saint Petersburg, 197101, Russia ³Aalto University, FI–00076 Aalto, Finland

⁴Ioffe Physical-Technical Institute, 26 Polytechnicheskaya str., Saint Petersburg, 194021, Russia *e-mail: sergey.karpov@str-soft.com

Abstract. Using the energy-balance approach, we have estimated critical thickness for misfit dislocation (MD) formation and wafer bow for single- and multi-layer InGaAs-based pseudomorphic heterostructures used in light-emitting devices. Indicating the onset of stress relaxation via MD formation, the analysis of critical thicknesses serves as a guideline for device structure design avoiding extensive defect generation usually accompanying the relaxation. Estimates of structure bow are helpful for meeting requirements of the wafer post-growth processing technology. Suggested methodology may be applied to optimization of strain-compensated semiconductor laser heterostructures.

1. Introduction

Bandgap engineering, including strain management, has become a powerful approach to development of state-of-the-art optoelectronic and electronic devices. It was successfully applied to reducing threshold current density of III-V semiconductor laser diodes [1], improving characteristics of pseudomorphic high electron mobility transistors [2], developing optoelectronic devices based on intra-band optical transitions, like intersubband infrared photo-detectors [3] and quantum-cascade lasers [4], expanding spectral range of tandem solar cells [5], etc. In optoelectronic devices, light-emitting diodes and laser diodes, the use of strained quantum well (QW) active regions enables smart choice of the most suitable semiconductor materials [6] and proper adjusting of the emission wavelength to practically important spectral ranges [7].

On the other hand, the use of strained layers creates additional problems. The first one is the well-known problem of misfit and threading dislocation (MD and TD) formation during the growth of strained epitaxial layers. In light-emitting diodes and laser diodes, MDs (and TDs) generated near (and in) the active region reduce substantially the internal quantum efficiency of the devices and lead to their accelerated degradation. In electronic devices, like high-electron mobility transistors, the dislocations enhance scattering of two-dimensional electrons, thus lowering their mobility and drift velocity. Therefore, avoiding dislocation formation in the strained device heterostructures is a key point of their design. The second problem is bowing of the grown wafers induced by built-in elastic strains. The bowing is undesirable for postgrowth device processing, as well as for the life-time of the devices in course of their operation.

In order to prevent the dislocation generation and diminish bow of strained

This implies the active regions of such lasers to include a single QW with the width less than the above found h_c . At higher x, the critical thickness diminishes to $h_c \approx 0.9$ nm in the case of pure InAs/GaAs.



Fig. 1. Critical thickness h_c of a single pseudomorphic $In_xGa_{1-x}As$ layer grown on either (001)InP or (001)GaAs substrate as a function of (a) alloy composition and (b) bandgap of bulk unstrained semiconductor. Dash-dotted line marks the composition of the alloy lattice-matched to InP. Vertical arrow indicates the bandgap corresponding to the emission wavelength of 1.55 µm.

The critical thicknesses of $In_xGa_{1-x}As$ grown on InP and GaAs becomes $h_c \approx 5.5$ nm at the InAs molar fraction x = 0.26. For layers with x > 0.26 grown on InP substrates, the critical thickness rises up and goes to infinity at x = 0.53 corresponding to InGaAs lattice-matched with InP and then decreases monotonically to the value $h_c \approx 2.8$ nm for InAs/InP.

Figure 1b shows h_c plotted as a function of bandgap of unstrained In_xGa_{1-x}As. The vertical arrow in the figure indicates the bandgap corresponding to the emission wavelength of 1.55 µm. At this bandgap, $h_c \approx 50$ nm, i.e. a quasi-bulk single layer may be chosen as the active region of light-emitting device with such wavelength. The latter estimate is based, however, on the spectral properties of the bulk unstrained In_xGa_{1-x}As alloys. In practice, thin single and multiple QWs (SQWs and MQWs) are employed in the laser diodes. Here, the lattice constant mismatch and the electron/hole quantum confinement result in the optical transition energies remarkably higher than the bandgap of the bulk materials. To compensate the joint effect of strain and quantum confinement, the QWs with increased Indium content are exploited. Estimates show that the bandgap of the bulk In_xGa_{1-x}As should be shifted to ~0.6-0.7 eV (x = 0.57-0.67), depending on QW width. This corresponds to h_c =10-60 nm that limit the allowable widths of the QWs used in the device structures.

To analyze wafer bow, we have considered a representative heterostructure containing five strained 4 nm InGaAs QWs sandwiched between other lattice-matched layers, which were grown on a 350 μ m (001) substrate made of either GaAs or InP. As the substrate thickness is much larger than the total thickness of the whole heterostructure, only the total thickness of the strained QWs but not the individual thicknesses of other layers is expected to determine the bow value. Figure 2 shows the wafer curvatures *K* as a function of the In_xGa_{1-x}As composition estimated by the approach mentioned in Sec. 2. The structure lattice-matched with InP provides zero curvature, whereas positive and negative curvatures correspond to the concave and convex wafer bending, respectively. The curvature of the structure with x = 0.22 grown on GaAs substrates is: K = -15 km⁻¹. That of the structures with x = 0.57-0.67 grown on InP, suitable for QW-based optoelectronic devices operating in the 1.55 µm spectral range, is varied between -2 and -10 km⁻¹.

A typical stage of the post-growth processing of semiconductor laser diodes is thinning of the substrate to \sim 100-120 µm prior separation of the wafer into individual laser bars. In this

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becomes shifted to higher x compared to that of the structure with the lattice-matched In_{0.53}Ga_{0.47}As barriers. In particular, the critical QW number in the practically interesting range x = 0.57-0.67 is predicted to vary from 6 to infinity. So, the use of the strain-compensated MQW structure enables substantial increase in the allowable number of QWs to be grown without stress relaxation.



Fig. 3. Critical QW number in a pseudomorphic MQW structure on (001)InP substrate as a function of InGaAs composition: 1 – structure with the QW barriers lattice-matched with InP, 2 – structure with strain-compensating In0.40Ga0.45Al0.15As barriers. Dash-dotted line marks the material lattice-matched with InP. Grey solid line indicates the quasi-matching conditions corresponding to zero effective stress (see text for details).

The advantages of strain-compensated structures resulting from possibility of controlling the quasi-matching of lattice constants ($\sigma_{eff} = 0$) are evident, if the mismatch stresses in both QWs and barriers are not so high. At high stresses, alternative relaxation mechanisms come into the play, like those studied in [22], leading eventually to extended defect formation. Determination of the workability range of strain-compensated structures is a task for future studies.

5. Conclusions

Using the energy-balance approach extended to the case of multi-layer heterostructures, we have estimated critical thickness and wafer bow for a set of pseudomorphic InGaAs-based structures on (001)GaAs and (001)InP substrates, close to those used for fabrication of light-emitting devices. For this purpose one of the model parameters, namely the dislocation core radius, has been adjusted to fit the critical thickness of the InAs layers on (001)GaAs substrate measured precisely during molecular beam epitaxy growth.

The estimates of the critical thicknesses provided for single $In_xGa_{1-x}As$ layers may serve as guideline for the choice of the width and composition of strained InGaAs QWs suitable for light emission in a practically important spectral ranges, on the one hand, and free from stress relaxation, on the other hand. The wafer bending predicted for a typical MQW structure is found to be rather substantial, which should be taken into account in post-growth processing of optoelectronic devices, such as light-emitting diodes and laser diodes.

Critical QW numbers corresponding to the onset of stress relaxation have been estimated for typical InGaAs MQW active regions of the laser diodes with the lattice-matched and strain-compensated barriers. The $In_xGa_{1-x}As$ composition "window" suitable for growth of relaxation-free MQW structures with a large number of QWs has been identified. The shift of the "window" predicted for the strain-compensated structure is controlled by quasi-matching conditions corresponding to zero effective stress.

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In view of the demonstrated practical advantages of using strain-compensated heterostructures, analysis of alternative mechanisms of stress relaxation that limit their workability seems to be of primary importance for future studies. Morphological undulation of the growth surface accompanied by the local generation of extended defects is expected to be one of such mechanisms.

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